

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4340798

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	HIROHISA IMADA	02/25/2013
RECEIVING PARTY DATA		
Name:	NIPPON VALQUA INDUSTRIES, LTD.	
Street Address:	1-1, OSAKI 2-CHOME, SHINAGAWA-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	141-6024	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14501540	
CORRESPONDENCE DATA		
Fax Number:	(202)822-1111	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	202-822-1100	
Email:	whdamail@whda.com	
Correspondent Name:	WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP	
Address Line 1:	1250 CONNECTICUT AVENUE	
Address Line 2:	SUITE 700	
Address Line 4:	NW, WASHINGTON, D.C. 20036	
ATTORNEY DOCKET NUMBER:	P5403US01	
NAME OF SUBMITTER:	MAO WANG	
SIGNATURE:	/Mao Wang/	
DATE SIGNED:	03/28/2017	
Total Attachments: 2		
source=151096A_Assignment#page1.tif		
source=151096A_Assignment#page2.tif		

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ASSIGNMENT

WHEREAS, I, Hirohisa IMADA, a citizen of Japan, residing at Gojo-shi, Nara, Japan, (hereinafter ASSIGNOR), have made a certain invention entitled Thermally Conductive Resin Composition and Thermally Conductive Sheet Including the Same for which I am making application for Letters Patent of the United States, which application has been executed concurrently herewith; and

WHEREAS, NIPPON VALQUA INDUSTRIES, LTD., a corporation duly organized under the laws of the state of Japan, located and doing business at 1-1, Osaki 2-chome, Shinagawa-ku, Tokyo 141-6024 Japan (hereinafter ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all Letters Patent to be obtained on said invention and/or application;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to me by said ASSIGNEE, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, by these presents do hereby sell, assign, set over and transfer unto said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States and all countries foreign thereto; and in, to and under the aforesaid United States application and any corresponding foreign applications and any provisional, divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in any country; and my right to file said foreign applications and claim priority under the provisions of the International Convention; and any Letters Patent of the United States or any foreign country issued or granted on said invention and/or said applications;

AND I HEREBY authorize and request the Patent Office or other issuing authority to issue any and all patents on said invention and/or said application to said ASSIGNEE as sole assignee; and I further hereby authorize said ASSIGNEE to file and prosecute any of said foreign applications in its own name;

AND I HEREBY covenant that I have the full right to convey the entire right, title and interest herein assigned and that I have not executed and will not execute any assignment or other instrument in conflict herewith;

AND I HEREBY further covenant and agree to communicate to said ASSIGNEE, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference purposes or other proceedings, whenever requested, and to testify in any interference or in any other legal proceeding, when requested, and to execute and deliver on request

all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses and to perform the aforesaid testifying for reasonable compensation; and generally to do everything possible to aid the said ASSIGNEE, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention in all countries, and likewise I make these provisions binding upon my heirs, legal representatives and/or administrators.

IN WITNESS WHEREOF, I have hereunder set my hand and seal this 25th day of February, 20 13.

Hirohisa Imada.
Hirohisa IMADA

Witness